HD74LS190 ●Synchronous Up/Down Decade Counters (single clock line)

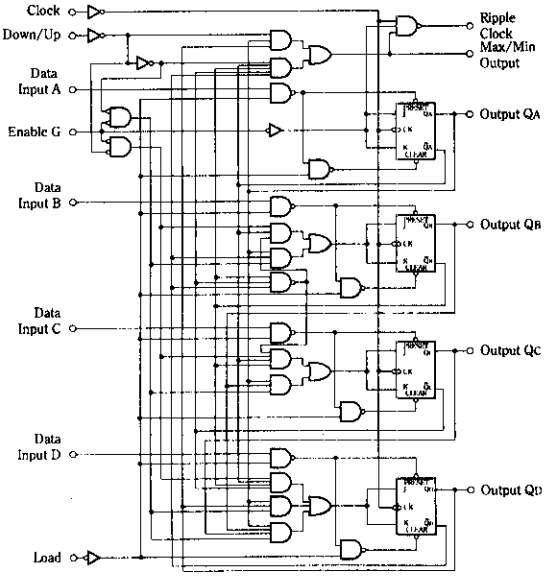
Synchronous operation is provided by having all flip-flops clocked simultaneously so that the outputs change coincident with each other when so instructed by the steering logic. This mode of operation eliminates the output counting spikes normally associated with asynchronous (ripple clock) counters.

The outputs of the four master-slave flip-flops are triggered on a low-to-high-level transition of the clock input if the enable input is low. A high at the enable input inhibits counting. Level changes at the enable input should be made only when the clock input is high. The direction of the count is determined by the level of the down/up input. When low, the counter counts up and when high, it counts down. Level changes at the down/up input should be made only when the clock input is high. This counter is fully programmable; that is, the outputs may be preset to either level by placing a low on the load input and entering the desired data at the data inputs. The output will change to agree with the data inputs independently of the level of the clock input. This feature allows the counters to be used as modulo-N dividers by simply modifying the count length with the preset inputs. The clock, down/up, and load inputs are buffered to lower the drive requirement which significantly reduces the number of clock drivers, etc., required for long parallel words.

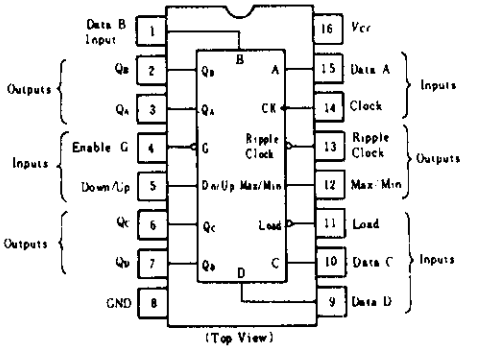
Two outputs have been made available to perform the cascading function: ripple clock and maximum/minimum count. The latter output produces a high-level output pulse with a duration approximately equal to one complete cycles to the clock when the counter overflows or underflows. The ripple clock output produces a low-level output pulse equal in width to the low-level portion of the clock input when an overflow or underflow conditions exists.

The counters can be easily cascaded by feeding the ripple clock output to the enable input of the succeeding counter if parallel clocking is used, or to the clock input if parallel enabling is used. The maximum/minimum count output can be used to accomplish look-ahead for high-speed operation.

■BLOCK DIAGRAM



■PIN ARRANGEMENT



■RECOMMENDED OPERATING CONDITIONS

Item	Symbol	min	typ	max	Unit
Clock frequency	f_{clock}	0	–	20	MHz
Clock pulse width	$t_{w(CK)}$	25	–	–	ns
Load input pulse width	$t_{w(load)}$	35	–	–	ns
Setup time	t_{su}	20	–	–	ns
Hold time	t_h	3	–	–	ns
Enable time	t_{enable}	40	–	–	ns

■ELECTRICAL CHARACTERISTICS ($Ta = -20 \sim +75°C$)

Item		Symbol	Test Conditions		min	typ*	max	Unit
Input voltage		V_{IH}			2.0		—	V
		V_{IL}			—		0.8	V
Output voltage		V_{OH}	$V_{CC}=4.75V$, $V_{IH}=2V$, $V_{IL}=0.8V$, $I_{OH}=-400\mu A$		2.7	—	—	V
		V_{OL}	$V_{CC}=4.75V$, $V_{IH}=2V$, $V_{IL}=0.8V$	$I_{OL}=4mA$	—	—	0.4	V
				$I_{OL}=8mA$	—	—	0.5	
Input current	Enable	I_{IH}	$V_{CC}=5.25V$, $V_I=2.7V$		—	—	60	μA
	Others				—	—	20	
	Enable	I_{IL}	$V_{CC}=5.25V$, $V_I=0.4V$		—	—	−1.2	mA
	Others				—	—	−0.4	
	Enable	I_I	$V_{CC}=5.25V$, $V_I=7V$		—	—	0.3	mA
	Others				—	—	0.1	
Short-circuit output current		I_{OS}	$V_{CC}=5.25V$		−20	—	−100	mA
Supply current**		I_{CC}	$V_{CC}=5.25V$		—	20	35	mA
Input clamp voltage		V_{IK}	$V_{CC}=4.75V$, $I_{IN}=-18mA$		—	—	−1.5	V

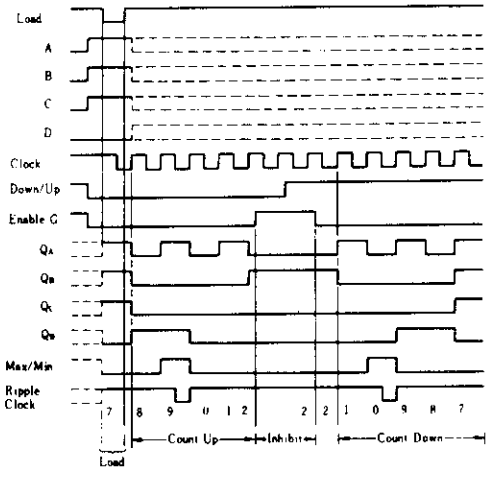
* V_{CC}=5V, Ta=25°C

** I_{CC} is measured with all outputs open and all inputs grounded.

■SWITCHING CHARACTERISTICS ($V_{CC}=5V$, $Ta=25°C$)

Item	Symbol	Inputs	Outputs	Test Conditions	min	typ	max	Unit
Maximum clock frequency	f_{max}	Clock	Q_A,Q_B,Q_C,Q_D	$C_L=15pF$, $R_L=2k\Omega$	20	25	—	MHz
Propagation delay time	t_{PLH}	Load	Q_A,Q_B,Q_C,Q_D		—	22	33	ns
	t_{PHL}				—	33	50	
	t_{PLH}	A, B, C, D	Q_A,Q_B,Q_C,Q_D		—	20	32	ns
	t_{PHL}				—	27	40	
	t_{PLH}	Clock	Ripple Clock		—	13	20	ns
	t_{PHL}				—	16	24	
	t_{PLH}	Clock	Q_A,Q_B,Q_C,Q_D		—	16	24	ns
	t_{PHL}				—	24	36	
	t_{PLH}	Clock	Max/Min		—	28	42	ns
	t_{PHL}				—	37	52	
	t_{PLH}	Down/Up	Ripple Clock		—	30	45	ns
	t_{PHL}				—	30	45	
	t_{PLH}	Down/Up	Max/Min		—	21	33	ns
	t_{PHL}				—	22	33	
	t_{PLH}	Enable	Ripple Clock		—	21	33	ns
	t_{PHL}				—	22	33	

■COUNT SEQUENCES

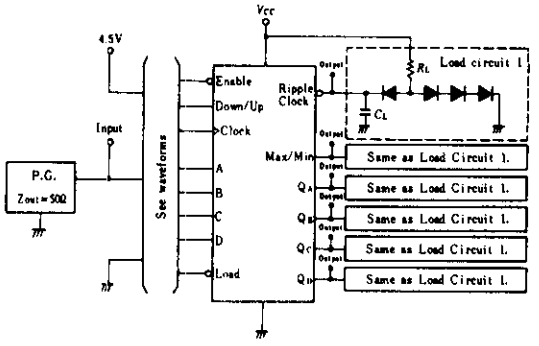


Illustrated below is the following sequence:

1. Load (preset) to BCD seven.
2. Count up to eight, nine (maximum), zero, one and two.
3. Inhibit
4. Count down to one, zero (minimum), nine, eight, and seven.

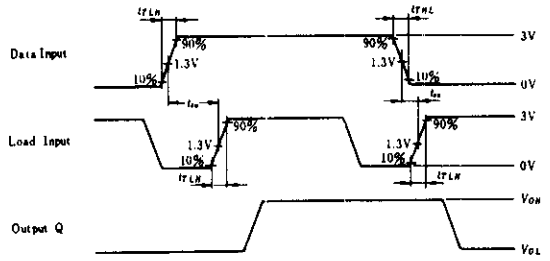
■TESTING METHOD

1) Test Circuit



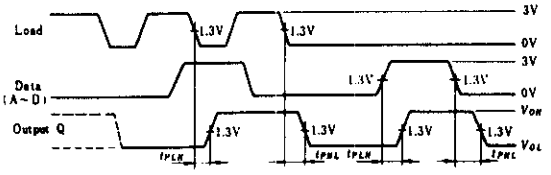
Notes) 1. C_L includes probe and jig capacitance.
2. All diodes are 1S2074 (H).

Waveform



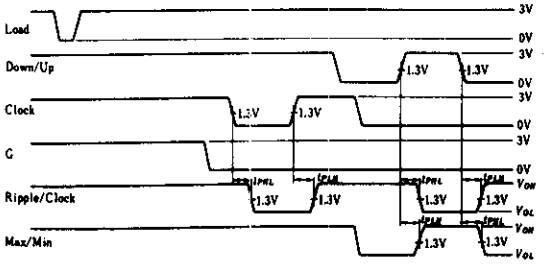
Input pulse: t_{TLH}, $t_{THL} \leqq 10$ns, PRR=1MHz, Duty cycle$\leqq$50%

Waveform 1. Load→Q, Data→Q



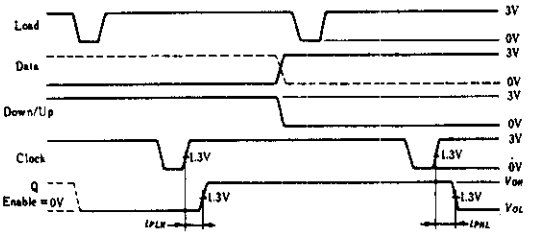
Note) Conditions on other inputs are irrelevant

Waveform 2. G→Ripple CK, CK→Ripple CK, Down/UP→Ripple CK, Down/Up→Max/Min



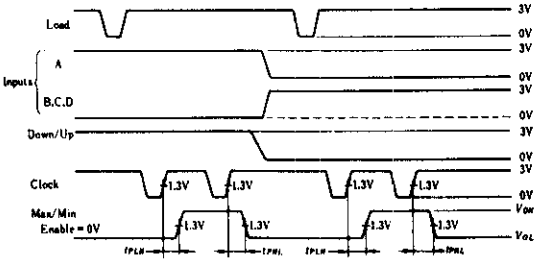
Note) All data inputs are low

Waveform 3. Clock→Q



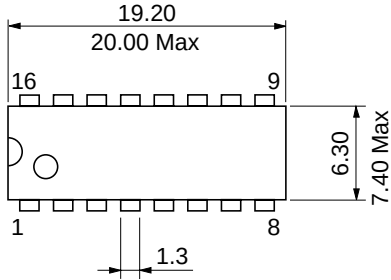
Notes) 1. When test the Q_A, Q_B, and Q_C outputs, data inputs A, B and C are shown by the solid line, and data input D is shown by the dashed line.
2. When test the Q_D output, data inputs A and D are shown by the solid line, and data inputs B and C are held at the low logic level.

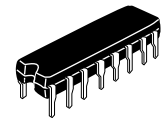
Waveform 4. Clock→Max/Min

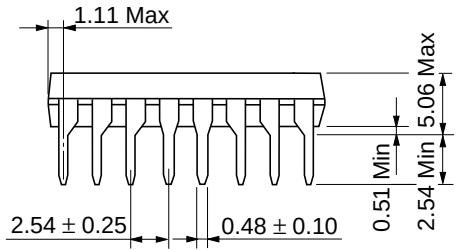


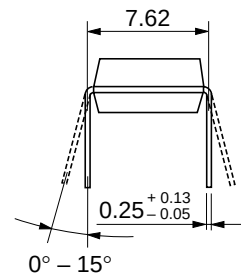
Note) Data inputs B and C are shown by the dashed line. Data input D is shown by the solid line.

Unit: mm



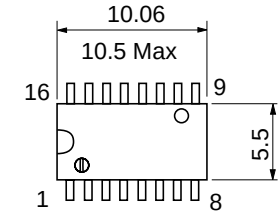


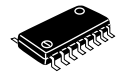


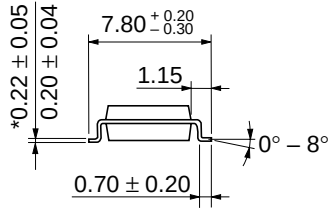


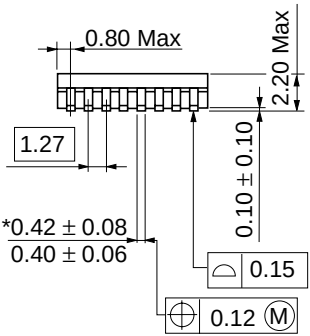
Hitachi Code	DP-16
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	1.07 g

Unit: mm





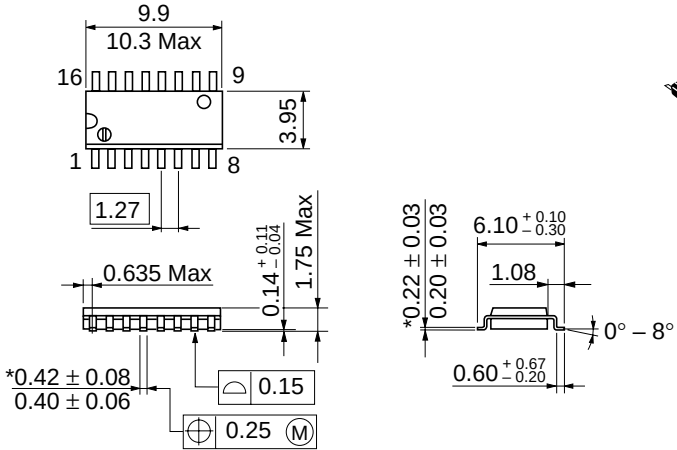




*Dimension including the plating thickness
Base material dimension

Hitachi Code	FP-16DA
JEDEC	—
EIAJ	Conforms
Weight (reference value)	0.24 g

Unit: mm



Hitachi Code	FP-16DN
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	0.15 g

*Dimension including the plating thickness
Base material dimension

Cautions

1. Hitachi neither warrants nor grants licenses of any rights of Hitachi's or any third party's patent, copyright, trademark, or other intellectual property rights for information contained in this document. Hitachi bears no responsibility for problems that may arise with third party's rights, including intellectual property rights, in connection with use of the information contained in this document.
2. Products and product specifications may be subject to change without notice. Confirm that you have received the latest product standards or specifications before final design, purchase or use.
3. Hitachi makes every attempt to ensure that its products are of high quality and reliability. However, contact Hitachi's sales office before using the product in an application that demands especially high quality and reliability or where its failure or malfunction may directly threaten human life or cause risk of bodily injury, such as aerospace, aeronautics, nuclear power, combustion control, transportation, traffic, safety equipment or medical equipment for life support.
4. Design your application so that the product is used within the ranges guaranteed by Hitachi particularly for maximum rating, operating supply voltage range, heat radiation characteristics, installation conditions and other characteristics. Hitachi bears no responsibility for failure or damage when used beyond the guaranteed ranges. Even within the guaranteed ranges, consider normally foreseeable failure rates or failure modes in semiconductor devices and employ systemic measures such as fail-safes, so that the equipment incorporating Hitachi product does not cause bodily injury, fire or other consequential damage due to operation of the Hitachi product.
5. This product is not designed to be radiation resistant.
6. No one is permitted to reproduce or duplicate, in any form, the whole or part of this document without written approval from Hitachi.
7. Contact Hitachi's sales office for any questions regarding this document or Hitachi semiconductor products.

HITACHI

Hitachi, Ltd.
Semiconductor & Integrated Circuits.
Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan
Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

URL
NorthAmerica : http:semiconductor.hitachi.com/
Europe : http://www.hitachi-eu.com/hel/ecg
Asia (Singapore) : http://www.has.hitachi.com.sg/grp3/sicd/index.htm
Asia (Taiwan) : http://www.hitachi.com.tw/E/Product/SICD_Frame.htm
Asia (HongKong) : http://www.hitachi.com.hk/eng/bo/grp3/index.htm
Japan : http://www.hitachi.co.jp/Sicd/indx.htm

For further information write to:

Hitachi Semiconductor
(America) Inc.
179 East Tasman Drive,
San Jose,CA 95134
Tel: <1> (408) 433-1990
Fax: <1>(408) 433-0223

Hitachi Europe GmbH
Electronic components Group
Dornacher Straße 3
D-85622 Feldkirchen, Munich
Germany
Tel: <49> (89) 9 9180-0
Fax: <49> (89) 9 29 30 00

Hitachi Europe Ltd.
Electronic Components Group.
Whitebrook Park
Lower Cookham Road
Maidenhead
Berkshire SL6 8YA, United Kingdom
Tel: <44> (1628) 585000
Fax: <44> (1628) 778322

Hitachi Asia Pte. Ltd.
16 Collyer Quay #20-00
Hitachi Tower
Singapore 049318
Tel: 535-2100
Fax: 535-1533

Hitachi Asia Ltd.
Taipei Branch Office
3F, Hung Kuo Building. No.167,
Tun-Hwa North Road, Taipei (105)
Tel: <886> (2) 2718-3666
Fax: <886> (2) 2718-8180

Hitachi Asia (Hong Kong) Ltd.
Group III (Electronic Components)
7/F., North Tower, World Finance Centre,
Harbour City, Canton Road, Tsim Sha Tsui,
Kowloon, Hong Kong
Tel: <852> (2) 735 9218
Fax: <852> (2) 730 0281
Telex: 40815 HITEC HX